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Venue

The Symposium will take place at Saigon Vissai Hotel in Ho Chi Minh City, Vietnam, which is located on the street from Tan Son Nhat Airport to downtown of Ho Chi Minh City. It takes about 5~8 minutes by taxi from Tan Son Nhat Airport to Saigon Vissai Hotel.

Registration

Registration by all participants, including invited speakers is mandatory.

Registration Fee

Regular Fee: 40,000 JPY (before [September 23, 2016](#))
50,000 JPY (after [September 24, 2016](#))
Accompanying Person Fee: 10,000 JPY
Student Fee: 10,000 JPY (before [September 23, 2016](#))
15,000 JPY (after [September 24, 2016](#))

The regular fee covers Symposium attendance, a volume of program and abstracts, a piece of CD-ROM proceedings, welcome party with drinks and nibbles (no meals), banquet, excursion and refreshments during coffee breaks. Note that the student fee does not cover either banquet or excursion.

Paper Submission, Selection and Publication

Abstracts of 300-500 words in English should be submitted online at the Symposium website. The abstracts should contain the following:

- (1) Title of paper.
- (2) Five keywords to describe and categorize the work.
- (3) Name, affiliation, address, e-mail address, telephone number and fax number of the author to whom subsequent correspondence should be directed.
- (4) Names and affiliations of co-authors, if any.
- (5) Background, objective, method, main findings and results.

The abstracts will be used for preliminary screening and planning for the sessions. Accepted abstracts should be submitted in the form of full-length manuscripts for review. Final acceptance will be based on review of the manuscripts. A bound volume of the abstracts and a piece of CD-ROM proceedings of the full-length papers will be available at the Symposium. Authors are invited to submit their papers to *Advanced Experimental Mechanics* published by the Japanese Society for Experimental Mechanics. For further detailed information, please visit the AEM Website (<http://www.jsem.jp/aem>).

Deadlines

Abstract submission: **May 13, 2016**
Notification of abstract acceptance: May 27, 2016
Full-length manuscript submission: August 5, 2016
Notification of full-length manuscript acceptance: August 31, 2016
Final manuscript due: September 23, 2016

For Further Information Contact

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For further information please visit <http://jsem.jp/ISEM11>

First Announcement and Call for Papers

The 11th International Symposium on Advanced Science and Technology in Experimental Mechanics (11th ISEM'16-Ho Chi Minh, Vietnam)

November 1-4, 2016

Saigon Vissai Hotel,
Ho Chi Minh City, Vietnam

<http://jsem.jp/ISEM11>



Organized by:

The Japanese Society for Experimental Mechanics

Supporting Organizations:

The Society for Experimental Mechanics, Inc (USA)
The British Society for Strain Measurement (UK)
The Japan Society of Mechanical Engineers (Japan)
The Japanese Society for Multiphase Flow (Japan)
The Visualization Society of Japan (Japan)
Heat Transfer Society of Japan (Japan)
The Iron and Steel Institute of Japan (Japan)
The Japan Institute of Metals (Japan)
The Japanese Society for Non-destructive Inspection (Japan)
The Japan Society for Design Engineering (Japan)
The Japanese Society for Medical and Biological Engineering (Japan)
The Japanese Society for Clinical Biomechanics (Japan)
The Japanese Society for Terramechanics (Japan)

Scope and Topics



Background and Aims

The Japanese Society for Experimental Mechanics (JSEM) was founded in 2001 by reorganizing the former Japan Society for Photoelasticity to extend its covering area of Experimental Mechanics not only to Solid Mechanics but also to various areas of Applied Mechanics such as Fluid Mechanics, Thermal Engineering, Medical Engineering, Biomechanics, Construction and Civil Engineering and so on. The first Symposium was successfully held in Sapporo, Japan (2006) to attain its main purpose of the new establishment. The Symposium was subsequently held in Osaka, Japan (2007), Tainan, Taiwan (2008), Niigata, Japan (2009), Kyoto, Japan (2010), Sendai/Kansai, Japan (2011), Taipei, Taiwan (2012), Sendai, Japan (2013), New Delhi, India (2014) and Matsue, Japan (2015).

The present Symposium aims to promote an exchange of recent and advanced information among scientists and engineers in the wide field of Experimental Mechanics with special focus on Environmental, Medical and Welfare Engineering. The Symposium is also aimed particularly at promoting communication and collaboration between fundamental researchers and those engaged in the development of practical technology in respective areas of Experimental Mechanics. This Symposium title was updated to The International Symposium on Advanced Science and Technology in Experimental Mechanics since the 5th ISEM'10-Kyoto, because the areas covered in the Symposium have been expanded as mentioned above.



Topics

We welcome papers in the following areas:

(I) Fundamentals

- (1) Fluid Dynamics
- (2) Multiphase Flow
- (3) Thermodynamics
- (4) Heat and Mass Transfer
- (5) Solid Mechanics / Strength of Materials
- (6) Material Engineering
- (7) Bioengineering
- (8) Civil Engineering
- (9) Sound and Vibration
- (10) Instrumentation and Testing
- (11) Visualization and Image Processing, and others

(II) Applications

- (1) Fluid Machinery
- (2) Fluid Flow in Micro- and Nano-scales
- (3) Environmental Science and Engineering
- (4) Advanced Energy and Power Systems
- (5) Combustion Technology
- (6) Medical and Welfare Engineering
- (7) Biomechanics and Biomaterials
- (8) Material Processing
- (9) Materials Testing and Fracture Mechanics Evaluation
- (10) Non-destructive Testing and Inspection
- (11) Optical Methods, Thermal Methods and X-ray Techniques
- (12) Transducer and Sensor Design
- (13) Safety Engineering, Risk Analysis and Reliability Methods
- (14) Smart Materials and Structural Health Monitoring
- (15) MEMS and NEMS
- (16) Recycling
- (17) Electronic Packaging
- (18) Engineering Education, and others

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